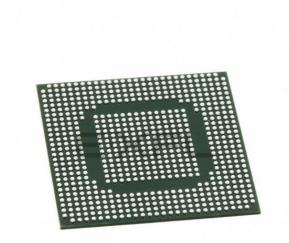
# Intel - 5CSEBA4U23C6N Datasheet





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#### Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

**Embedded - System On Chip (SoC)** refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

#### What are Embedded - System On Chip (SoC)?

**System On Chip (SoC)** integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions. SoCs combine a central

#### Details

Product Status	Active
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore <sup>™</sup> with CoreSight <sup>™</sup>
Flash Size	-
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	CANbus, EBI/EMI, Ethernet, I <sup>2</sup> C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	925MHz
Primary Attributes	FPGA - 40K Logic Elements
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-FBGA
Supplier Device Package	672-UBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5cseba4u23c6n

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



# **Summary of Cyclone V Features**

# Table 2. Summary of Features for Cyclone V Devices

Feature		Description
Technology	<ul><li>TSMC's 28-nm low-p</li><li>1.1 V core voltage</li></ul>	ower (28LP) process technology
Packaging	<ul> <li>Wirebond low-haloge</li> <li>Multiple device densi different device dens</li> <li>RoHS-compliant and</li> </ul>	ties with compatible package footprints for seamless migration between ities
High-performance FPGA fabric	Enhanced 8-input ALM w	vith four registers
Internal memory blocks		b) memory blocks with soft error correction code (ECC) block (MLAB)—640-bit distributed LUTRAM where you can use up to 25% memory
Embedded Hard IP blocks	Variable-precision DSP	<ul> <li>Native support for up to three signal processing precision levels (three 9 x 9, two 18 x 18, or one 27 x 27 multiplier) in the same variable-precision DSP block</li> <li>64-bit accumulator and cascade</li> <li>Embedded internal coefficient memory</li> <li>Preadder/subtractor for improved efficiency</li> </ul>
	Memory controller	DDR3, DDR2, and LPDDR2 with 16 and 32 bit ECC support
	Embedded transceiver I/O	PCI Express* (PCIe*) Gen2 and Gen1 (x1, x2, or x4) hard IP with multifunction support, endpoint, and root port
Clock networks	, , , ,	l clock network d peripheral clock networks are not used can be powered down to reduce dynamic power
Phase-locked loops (PLLs)	<ul><li> Precision clock synth</li><li> Integer mode and fra</li></ul>	esis, clock delay compensation, and zero delay buffering (ZDB) actional mode
FPGA General-purpose I/Os (GPIOs)	<ul><li>400 MHz/800 Mbps e</li><li>On-chip termination</li></ul>	cond (Mbps) LVDS receiver and 840 Mbps LVDS transmitter external memory interface (OCT) p to 16 mA drive strength
Low-power high-speed serial interface	Transmit pre-emphase	ibps integrated transceiver speed sis and receiver equalization nfiguration of individual channels
HPS (Cyclone V SE, SX, and ST devices only)	<ul> <li>support for symmetr</li> <li>Interface peripherals</li> <li>On-The-GO (OTG) co</li> <li>flash controller, Secu</li> <li>network (CAN), seria</li> <li>interfaces</li> </ul>	rm Cortex-A9 MPCore processor-up to 925 MHz maximum frequency with ic and asymmetric multiprocessing —10/100/1000 Ethernet media access control (EMAC), USB 2.0 introller, quad serial peripheral interface (QSPI) flash controller, NAND re Digital/MultiMediaCard (SD/MMC) controller, UART, controller area il peripheral interface (SPI), I <sup>2</sup> C interface, and up to 85 HPS GPIO
		-general-purpose timers, watchdog timers, direct memory access (DMA) iguration manager, and clock and reset managers
		continued

<sup>&</sup>lt;sup>(1)</sup> Contact Intel for availability.



Feature	Description
	<ul> <li>HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa</li> <li>FPGA-to-HPS SDRAM controller subsystem—provides a configurable interface to the multiport front end (MPFE) of the HPS SDRAM controller</li> <li>Arm CoreSight<sup>™</sup> JTAG debug access port, trace port, and on-chip trace storage</li> </ul>
Configuration	<ul> <li>Tamper protection—comprehensive design protection to protect your valuable IP investments</li> <li>Enhanced advanced encryption standard (AES) design security features</li> <li>CvP</li> <li>Dynamic reconfiguration of the FPGA</li> <li>Active serial (AS) x1 and x4, passive serial (PS), JTAG, and fast passive parallel (FPP) x8 and x16 configuration options</li> <li>Internal scrubbing <sup>(2)</sup></li> <li>Partial reconfiguration <sup>(3)</sup></li> </ul>

# **Cyclone V Device Variants and Packages**

## Table 3. Device Variants for the Cyclone V Device Family

Variant	Description
Cyclone V E	Optimized for the lowest system cost and power requirement for a wide spectrum of general logic and DSP applications
Cyclone V GX	Optimized for the lowest cost and power requirement for 614 Mbps to 3.125 Gbps transceiver applications
Cyclone V GT	The FPGA industry's lowest cost and lowest power requirement for 6.144 Gbps transceiver applications
Cyclone V SE	SoC with integrated Arm-based HPS
Cyclone V SX	SoC with integrated Arm-based HPS and 3.125 Gbps transceivers
Cyclone V ST	SoC with integrated Arm-based HPS and 6.144 Gbps transceivers

# Cyclone V E

This section provides the available options, maximum resource counts, and package plan for the Cyclone V E devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Product Selector Guide.

#### **Related Information**

#### Product Selector Guide

Provides the latest information about Intel products.

<sup>(2)</sup> The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

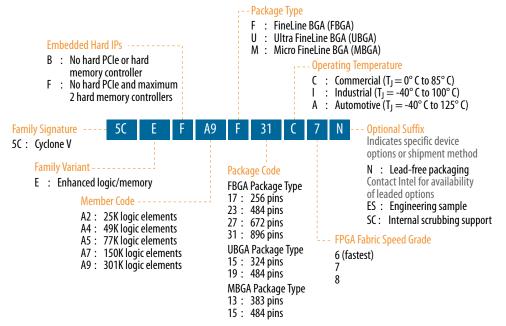
<sup>(3)</sup> The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel<sup>®</sup> sales representatives.



# **Available Options**

### Figure 1. Sample Ordering Code and Available Options for Cyclone V E Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.



## **Maximum Resources**

#### Table 4. Maximum Resource Counts for Cyclone V E Devices

Resource			Member Code				
		A2	A4	A5	A7	A9	
Logic Elements	(LE) (K)	25	49	77	150	301	
ALM		9,430	18,480	29,080	56,480	113,560	
Register		37,736	73,920	116,320	225,920	454,240	
Memory (Kb)	M10K	1,760	3,080	4,460	6,860	12,200	
	MLAB	196	303	424	836	1,717	
Variable-precisi	on DSP Block	25	66	150	156	342	
18 x 18 Multipli	er	50	132	300	312	684	
PLL		4	4	6	7	8	
GPIO		224	224	240	480	480	
LVDS	Transmitter	56	56	60	120	120	
	Receiver	56	56	60	120	120	
Hard Memory C	ontroller	1	1	2	2	2	



### **Related Information**

True LVDS Buffers in Devices, I/O Features in Cyclone V Devices Provides the number of LVDS channels in each device package.

### **Package Plan**

#### Table 5. Package Plan for Cyclone V E Devices

Member Code	M383 (13 mm)	M484 (15 mm)	U324 (15 mm)	F256 (17 mm)	U484 (19 mm)	F484 (23 mm)	F672 (27 mm)	F896 (31 mm)
	GPIO							
A2	223	-	176	128	224	224	-	_
A4	223	-	176	128	224	224	-	_
A5	175	-	_	_	224	240	-	_
A7	-	240	_	_	240	240	336	480
A9	-	-	-	_	240	224	336	480

# **Cyclone V GX**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

### **Related Information**

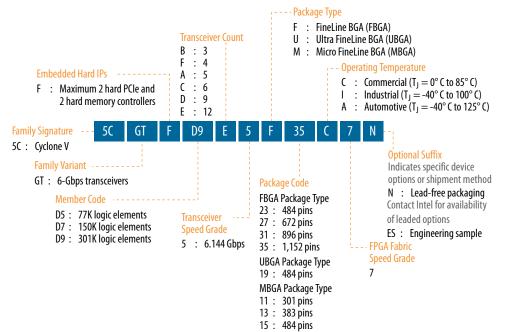
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# **Available Options**

## Figure 3. Sample Ordering Code and Available Options for Cyclone V GT Devices



### **Maximum Resources**

#### Table 8. Maximum Resource Counts for Cyclone V GT Devices

Resource			Member Code				
		D5	D7	D9			
Logic Elements (LE) (	К)	77	150	301			
ALM		29,080	56,480	113,560			
Register		116,320	225,920	454,240			
Memory (Kb)	M10K	4,460	6,860	12,200			
	MLAB	424	836	1,717			
Variable-precision DS	P Block	150	156	342			
18 x 18 Multiplier		300	312	684			
PLL		6	7	8			
6 Gbps Transceiver		6	9	12			
GPIO <sup>(5)</sup>		336	480	560			
LVDS	Transmitter	84	120	140			
				continued			

<sup>&</sup>lt;sup>(5)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.



# **Cyclone V SE**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V SE devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

#### **Related Information**

#### Product Selector Guide

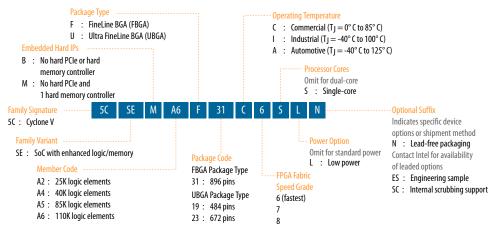
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## **Available Options**

#### Figure 4. Sample Ordering Code and Available Options for Cyclone V SE Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Cyclone V SE and SX low-power devices (L power option) offer 30% static power reduction for devices with 25K LE and 40K LE, and 20% static power reduction for devices with 85K LE and 110K LE.







# **Cyclone V SX**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

#### **Related Information**

#### Product Selector Guide

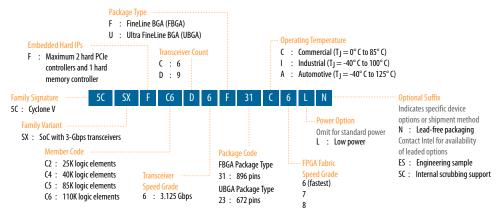
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## **Available Options**

### Figure 5. Sample Ordering Code and Available Options for Cyclone V SX Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Cyclone V SE and SX low-power devices (L power option) offer 30% static power reduction for devices with 25K LE and 40K LE, and 20% static power reduction for devices with 85K LE and 110K LE.



### **Maximum Resources**

### Table 12. Maximum Resource Counts for Cyclone V SX Devices

Reso	urce	Member Code				
		C2	C4	C5	C6	
Logic Elements (LE)	(K)	25	40	85	110	
ALM		9,430	15,880	32,070	41,910	
Register		37,736	60,376	128,300	166,036	
Memory (Kb)	M10K	1,400	2,700	3,970	5,570	
	MLAB	138	231	480	621	
Variable-precision D	SP Block	36	84	87	112	
18 x 18 Multiplier		72	168	174	224	
FPGA PLL		5	5	6	6	
			•		continued.	



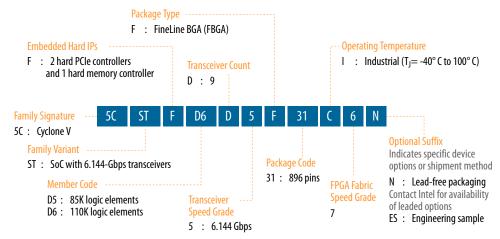
## **Related Information**

Product Selector Guide

Provides the latest information about Intel products.

## **Available Options**

### Figure 6. Sample Ordering Code and Available Options for Cyclone V ST Devices



## **Maximum Resources**

### Table 14. Maximum Resource Counts for Cyclone V ST Devices

Res	ource	Member	r Code
		D5	D6
Logic Elements (LE) (K)		85	110
ALM		32,070	41,910
Register		128,300	166,036
Memory (Kb)	M10K	3,970	5,570
	MLAB	480	621
Variable-precision DSP Block		87	112
18 x 18 Multiplier		174	224
FPGA PLL		6	6
HPS PLL		3	3
6.144 Gbps Transceiver	4 Gbps Transceiver		9
FPGA GPIO <sup>(10)</sup>		288	288
HPS I/O		181	181
LVDS	Transmitter	72	72
	-		continued

<sup>&</sup>lt;sup>(10)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

#### Cyclone V Device Overview CV-51001 | 2018.05.07



Resource		Member Code		
		D5	D6	
	Receiver	72	72	
PCIe Hard IP Block		2	2	
FPGA Hard Memory Controller		1	1	
HPS Hard Memory Controller		1	1	
Arm Cortex-A9 MPCore Processor		Dual-core	Dual-core	

#### **Related Information**

# True LVDS Buffers in Devices, I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.

## **Package Plan**

### Table 15. Package Plan for Cyclone V ST Devices

- The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPSspecific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.
- Transceiver counts shown are for transceiver ≤5 Gbps . 6 Gbps transceiver channel count support depends on the package and channel usage. For more information about the 6 Gbps transceiver channel count, refer to the *Cyclone V Device Handbook Volume 2: Transceivers*.

Member Code	F896 (31 mm)				
	FPGA GPIO         HPS I/O         XCVR				
D5	288	181	9 (11)		
D6	288	181	9 (11)		

## **Related Information**

6.144-Gbps Support Capability in Cyclone V GT Devices, Cyclone V Device Handbook Volume 2: Transceivers

Provides more information about 6 Gbps transceiver channel count.

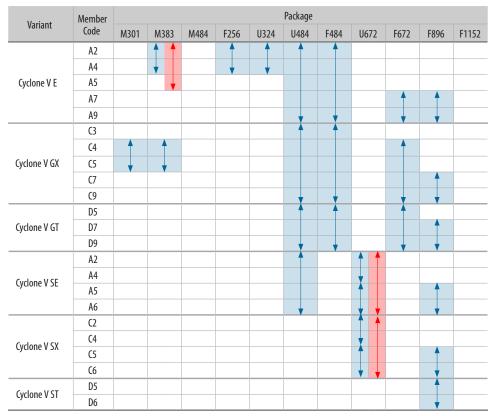
<sup>(11)</sup> If you require CPRI (at 4.9152 Gbps) and PCIe Gen2 transmit jitter compliance, Intel recommends that you use only up to seven full-duplex transceiver channels for CPRI, and up to six full-duplex channels for PCIe Gen2. The CMU channels are not considered full-duplex channels.



# **I/O Vertical Migration for Cyclone V Devices**

### Figure 7. Vertical Migration Capability Across Cyclone V Device Packages and Densities

The arrows indicate the vertical migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.



You can achieve the vertical migration shaded in red if you use only up to 175 GPIOs for the M383 package, and 138 GPIOs for the U672 package. These migration paths are not shown in the Intel Quartus Prime software Pin Migration View.

*Note:* To verify the pin migration compatibility, use the Pin Migration View window in the Intel Quartus Prime software Pin Planner.

# **Adaptive Logic Module**

Cyclone V devices use a 28 nm ALM as the basic building block of the logic fabric.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than previous generations.



## Table 16. Variable-Precision DSP Block Configurations for Cyclone V Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resource
Low precision fixed point for video applications	Three 9 x 9	1
Medium precision fixed point in FIR filters	Two 18 x 18	1
FIR filters and general DSP usage	Two 18 x 18 with accumulate	1
High precision fixed- or floating-point implementations	One 27 x 27 with accumulate	1

You can configure each DSP block during compilation as independent three 9 x 9, two  $18 \times 18$ , or one  $27 \times 27$  multipliers. With a dedicated 64 bit cascade bus, you can cascade multiple variable-precision DSP blocks to implement even higher precision DSP functions efficiently.

### Table 17. Number of Multipliers in Cyclone V Devices

The table lists the variable-precision DSP resources by bit precision for each Cyclone V device.

Variant I	Member Code	Variable- precision DSP Block		dent Input an plications Ope		18 x 18 Multiplier	18 x 18 Multiplier Adder
		DSP BIOCK	9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	Adder Mode	Adder Summed with 36 bit Input
Cyclone V E	A2	25	75	50	25	25	25
	A4	66	198	132	66	66	66
-	A5	150	450	300	150	150	150
	A7	156	468	312	156	156	156
	A9	342	1,026	684	342	342	342
Cyclone V	C3	57	171	114	57	57	57
GX	C4	70	210	140	70	70	70
-	C5	150	450	300	150	150	150
	C7	156	468	312	156	156	156
	C9	342	1,026	684	342	342	342
Cyclone V GT	D5	150	450	300	150	150	150
	D7	156	468	312	156	156	156
-	D9	342	1,026	684	342	342	342
Cyclone V SE	A2	36	108	72	36	36	36
-	A4	84	252	168	84	84	84
-	A5	87	261	174	87	87	87
	A6	112	336	224	112	112	112
Cyclone V SX	C2	36	108	72	36	36	36
	C4	84	252	168	84	84	84
	C5	87	261	174	87	87	87
							continued



Variant	Member Code	Code precision		dent Input and plications Ope	18 x 18 Multiplier Adder Mode	18 x 18 Multiplier	
		DSP Block	9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	Adder Mode	Adder Summed with 36 bit Input
	C6	112	336	224	112	112	112
Cyclone V ST	D5	87	261	174	87	87	87
	D6	112	336	224	112	112	112

# **Embedded Memory Blocks**

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.

# **Types of Embedded Memory**

The Cyclone V devices contain two types of memory blocks:

- 10 Kb M10K blocks—blocks of dedicated memory resources. The M10K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Cyclone V devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

# **Embedded Memory Capacity in Cyclone V Devices**

## Table 18. Embedded Memory Capacity and Distribution in Cyclone V Devices

	Member	M1	.0К	ML	Total RAM Bit	
Variant	Code	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	(Kb)
Cyclone V E	A2	176	1,760	314	196	1,956
	A4	308	3,080	485	303	3,383
	A5	446	4,460	679	424	4,884
	A7	686	6,860	1338	836	7,696
	A9	1,220	12,200	2748	1,717	13,917
Cyclone V GX	C3	135	1,350	291	182	1,532
	C4	250	2,500	678	424	2,924
	C5	446	4,460	678	424	4,884
	C7	686	6,860	1338	836	7,696
	C9	1,220	12,200	2748	1,717	13,917
	continued					



	Member	M10K		ML	Total RAM Bit	
Variant	Code	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	(Kb)
Cyclone V GT	D5	446	4,460	679	424	4,884
	D7	686	6,860	1338	836	7,696
	D9	1,220	12,200	2748	1,717	13,917
Cyclone V SE	A2	140	1,400	221	138	1,538
	A4	270	2,700	370	231	2,460
	A5	397	3,970	768	480	4,450
	A6	553	5,530	994	621	6,151
Cyclone V SX	C2	140	1,400	221	138	1,538
	C4	270	2,700	370	231	2,460
	C5	397	3,970	768	480	4,450
	C6	553	5,530	994	621	6,151
Cyclone V ST	D5	397	3,970	768	480	4,450
	D6	553	5,530	994	621	6,151

# **Embedded Memory Configurations**

## Table 19. Supported Embedded Memory Block Configurations for Cyclone V Devices

This table lists the maximum configurations supported for the embedded memory blocks. The information is applicable only to the single-port RAM and ROM modes.

Memory Block	Depth (bits)	Programmable Width
MLAB	32	x16, x18, or x20
M10K	256	x40 or x32
	512	x20 or x16
	1К	x10 or x8
	2К	x5 or x4
	4К	x2
	8К	×1

# **Clock Networks and PLL Clock Sources**

550 MHz Cyclone V devices have 16 global clock networks capable of up to operation. The clock network architecture is based on Intel's global, quadrant, and peripheral clock structure. This clock structure is supported by dedicated clock input pins and fractional PLLs.

*Note:* To reduce power consumption, the Intel Quartus Prime software identifies all unused sections of the clock network and powers them down.



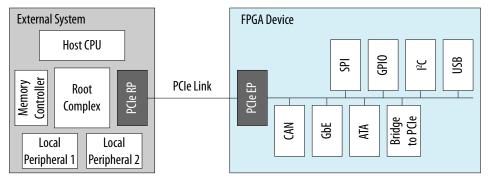
# PCIe Gen1 and Gen2 Hard IP

Cyclone V GX, GT, SX, and ST devices contain PCIe hard IP that is designed for performance and ease-of-use. The PCIe hard IP consists of the MAC, data link, and transaction layers.

The PCIe hard IP supports PCIe Gen2 and Gen1 end point and root port for up to x4 lane configuration. The PCIe Gen2 x4 support is PCIe-compatible.

The PCIe endpoint support includes multifunction support for up to eight functions, as shown in the following figure. The integrated multifunction support reduces the FPGA logic requirements by up to 20,000 LEs for PCIe designs that require multiple peripherals.

### Figure 9. PCIe Multifunction for Cyclone V Devices



The Cyclone V PCIe hard IP operates independently from the core logic. This independent operation allows the PCIe link to wake up and complete link training in less than 100 ms while the Cyclone V device completes loading the programming file for the rest of the device.

In addition, the PCIe hard IP in the Cyclone V device provides improved end-to-end datapath protection using ECC.

# **External Memory Interface**

This section provides an overview of the external memory interface in Cyclone V devices.

## Hard and Soft Memory Controllers

Cyclone V devices support up to two hard memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices. Each controller supports 8 to 32 bit components of up to 4 gigabits (Gb) in density with two chip selects and optional ECC. For the Cyclone V SoC devices, an additional hard memory controller in the HPS supports DDR3, DDR2, and LPDDR2 SDRAM devices.

All Cyclone V devices support soft memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices for maximum flexibility.



# **External Memory Performance**

### Table 20. External Memory Interface Performance in Cyclone V Devices

The maximum and minimum operating frequencies depend on the memory interface standards and the supported delay-locked loop (DLL) frequency listed in the device datasheet.

Interface	Voltage	Maximum Free	Minimum Frequency	
	(V)	Hard Controller	Soft Controller	(MHz)
DDR3 SDRAM	1.5	400	303	303
	1.35	400	303	303
DDR2 SDRAM	1.8	400	300	167
LPDDR2 SDRAM	1.2	333	300	167

#### **Related Information**

External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Intel's External Memory Interface Spec Estimator tool.

# **HPS External Memory Performance**

## Table 21. HPS External Memory Interface Performance

The hard processor system (HPS) is available in Cyclone V SoC devices only.

Interface	Voltage (V)	HPS Hard Controller (MHz)
DDR3 SDRAM	1.5	400
	1.35	400
DDR2 SDRAM	1.8	400
LPDDR2 SDRAM	1.2	333

### **Related Information**

#### External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Intel's External Memory Interface Spec Estimator tool.

# **Low-Power Serial Transceivers**

Cyclone V devices deliver the industry's lowest power 6.144 Gbps transceivers at an estimated 88 mW maximum power consumption per channel. Cyclone V transceivers are designed to be compliant with a wide range of protocols and data rates.

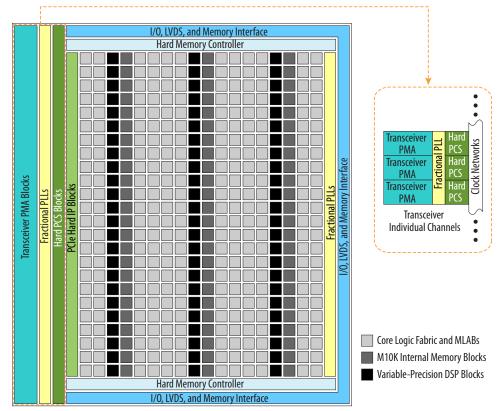
# **Transceiver Channels**

The transceivers are positioned on the left outer edge of the device. The transceiver channels consist of the physical medium attachment (PMA), physical coding sublayer (PCS), and clock networks.



#### Figure 10. Device Chip Overview for Cyclone V GX and GT Devices

The figure shows a Cyclone V FPGA with transceivers. Different Cyclone V devices may have a different floorplans than the one shown here.



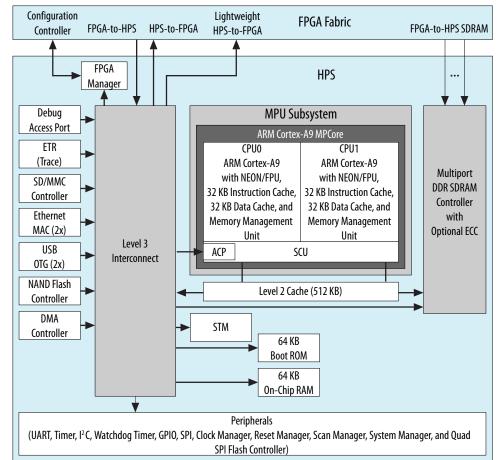
## **PMA Features**

To prevent core and I/O noise from coupling into the transceivers, the PMA block is isolated from the rest of the chip—ensuring optimal signal integrity. For the transceivers, you can use the channel PLL of an unused receiver PMA as an additional transmit PLL.

#### Table 22. PMA Features of the Transceivers in Cyclone V Devices

Features	Capability
Backplane support	Driving capability up to 6.144 Gbps
PLL-based clock recovery	Superior jitter tolerance
Programmable deserialization and word alignment	Flexible deserialization width and configurable word alignment pattern
Equalization and pre-emphasis	<ul> <li>Up to 14.37 dB of pre-emphasis and up to 4.7 dB of equalization</li> <li>No decision feedback equalizer (DFE)</li> </ul>
Ring oscillator transmit PLLs	614 Mbps to 6.144 Gbps
Input reference clock range	20 MHz to 400 MHz
Transceiver dynamic reconfiguration	Allows the reconfiguration of a single channel without affecting the operation of other channels





## Figure 11. HPS with Dual-Core Arm Cortex-A9 MPCore Processor

## **System Peripherals and Debug Access Port**

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals to interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports Arm CoreSight debug and core traces to facilitate software development.



Apart from lowering cost and power consumption, partial reconfiguration increases the effective logic density of the device because placing device functions that do not operate simultaneously is not necessary. Instead, you can store these functions in external memory and load them whenever the functions are required. This capability reduces the size of the device because it allows multiple applications on a single device—saving the board space and reducing the power consumption.

Intel simplifies the time-intensive task of partial reconfiguration by building this capability on top of the proven incremental compile and design flow in the Intel Quartus Prime design software. With the Intel solution, you do not need to know all the intricate device architecture details to perform a partial reconfiguration.

Partial reconfiguration is supported through the FPP x16 configuration interface. You can seamlessly use partial reconfiguration in tandem with dynamic reconfiguration to enable simultaneous partial reconfiguration of both the device core and transceivers.

# **Enhanced Configuration and Configuration via Protocol**

Cyclone V devices support 1.8 V, 2.5 V, 3.0 V, and 3.3 V programming voltages and several configuration schemes.

Mode	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompressi on	Design Security	Partial Reconfigurat ion <sup>(18)</sup>	Remote System Update
AS through the EPCS and EPCQ serial configuration device	1 bit, 4 bits	100	_	Yes	Yes	_	Yes
PS through CPLD or external microcontroller	1 bit	125	125	Yes	Yes	_	_
FPP	8 bits	125	_	Yes	Yes	_	Parallel flash
	16 bits	125	_	Yes	Yes	Yes	loader
CvP (PCIe)	x1, x2, and x4 lanes	-	_	Yes	Yes	Yes	_
JTAG	1 bit	33	33	-	_	_	_

 Table 24.
 Configuration Schemes and Features Supported by Cyclone V Devices

Instead of using an external flash or ROM, you can configure the Cyclone V devices through PCIe using CvP. The CvP mode offers the fastest configuration rate and flexibility with the easy-to-use PCIe hard IP block interface. The Cyclone V CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

## **Related Information**

Configuration via Protocol (CvP) Implementation in Intel FPGAs User Guide Provides more information about CvP.

<sup>&</sup>lt;sup>(18)</sup> The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.



# **Power Management**

Leveraging the FPGA architectural features, process technology advancements, and transceivers that are designed for power efficiency, the Cyclone V devices consume less power than previous generation Cyclone FPGAs:

- Total device core power consumption—less by up to 40%.
- Transceiver channel power consumption—less by up to 50%.

Additionally, Cyclone V devices contain several hard IP blocks that reduce logic resources and deliver substantial power savings of up to 25% less power than equivalent soft implementations.

# **Document Revision History for Cyclone V Device Overview**

Document Version	Changes
2018.05.07	<ul> <li>Added the low power option ("L" suffix) for Cyclone V SE and Cyclone V SX devices in the Sample Ordering Code and Available Options diagrams.</li> <li>Rebranded as Intel.</li> </ul>

Date	Version	Changes
December 2017	2017.12.18	Updated ALM resources for Cyclone V E, Cyclone V SE, Cyclone V SX, and Cyclone V ST devices.
June 2016	2016.06.10	Updated Cyclone V GT speed grade to $-7$ in Sample Ordering Code and Available Options for Cyclone V GT Devices diagram.
December 2015	2015.12.21	<ul> <li>Added descriptions to package plan tables for Cyclone V GT and ST devices.</li> <li>Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>.</li> </ul>
June 2015	2015.06.12	<ul> <li>Replaced a note to partial reconfiguration feature. Note: The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Altera sales representatives.</li> <li>Updated logic elements (LE) (K) for the following devices: <ul> <li>Cyclone V E A7: Updated from 149.5 to 150</li> <li>Cyclone V GX C3: Updated from 149.7 to 150</li> <li>Cyclone V GT D7: Updated from 149.5 to 150</li> <li>Cyclone V GT D7: Updated from 149.5 to 150</li> </ul> </li> <li>Updated MLAB (Kb) in Maximum Resource Counts for Cyclone V GX Devices table as follows: <ul> <li>Cyclone V GX C3: Updated from 291 to 182</li> <li>Cyclone V GX C4: Updated from 678 to 424</li> <li>Cyclone V GX C7: Updated from 1,338 to 836</li> <li>Cyclone V GX C9: Updated from 1,717</li> </ul> </li> </ul>
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aid A6.       Updated Memory (Kb) for Maximum Resource Counts for Cyclone V SE A and A6, SX C4 and C6, ST D6 devices.         Updated PGA PLL for Maximum Resource Counts for Cyclone V SE A2, S (2, devices.       Removed '36 x 36' from the Variable-Precision DSP Block.         Updated HPG PLL for Maximum Resource Counts for Cyclone V SE A4, SC (2, devices.       Not and ST devices.         Updated HPS I/O counts for Cyclone V SX C4 device.       Updated HPS I/O counts for Cyclone V SX C4 device.         Updated HPS I/O counts for Cyclone V SX C4 device.       Updated HPS I/O counts for Cyclone V SX C4 device.         Updated Memory Capacity and Distribution table for Cyclone SE A4 and A6, SX C4 and C6, ST D6 devices.       Removed 'Gounter reconfiguration' from the PLL Features.         Updated Low-Power Serial Transceivers by replacing 5 Gbps with 6.144 Gbps.       Removed 'Distributed Memory' symbol.         Updated the Capability in Table 23 of Dackplane support to '6.144 Gbps'.       Updated the Data Rates (Gbps) in Table 23 of CPRI 4.1 to '6.144 Gbps'.         Updated the partial reconfiguration is an advanced feature. Contact Atte for support of the feature.       Oteps:         December 2012       2012.12.28       Updated the OFIO counts for the MBGA packages.         Updated the option tors for the MBGA packages.       Updated the OFIO counts for the VH44 package of the Cyclone V E A9, C (9, and GT) ad devices.         November 2012       2012.11.19       Added new MBGA packages and additional U449 packages.         Updated the vertical migrati	Date	Version	Changes
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